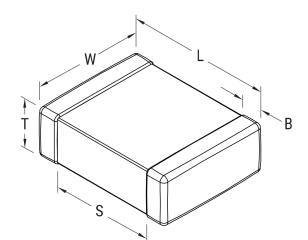


C0402C563J9RAC7411

SMD Comm X7R, Ceramic, 0.056 uF, 5%, 6.3 VDC, X7R, SMD, MLCC, Temperature Stable, Class II, 0402



Click here for the 3D model.

Dimensions	
Chip Size	0402
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
т	0.5mm +/-0.05mm
S	0.3mm MIN
В	0.3mm +/-0.1mm

Packaging Specifications

Packaging Packaging Quantity T&R, 330mm, Paper Tape 50000

General Information	
Series	SMD Comm X7R
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Class II
Features	Temperature Stable, Class II
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	1210 ug
Shelf Life	78 Weeks
MSL	1

Specifications		
Capacitance	0.056 uF	
Measurement Condition	1 kHz 1.0Vrms	
Capacitance Tolerance	5%	
Voltage DC	6.3 VDC	
Dielectric Withstanding Voltage	15.75 VDC	
Temperature Range	-55/+125°C	
Temperature Coefficient	X7R	
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms	
Dissipation Factor	5%1kHz1.0Vrms	
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours	
Insulation Resistance	8.9286 GOhms	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)